

### Features

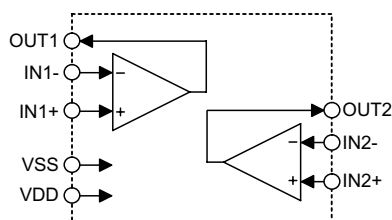
- Single power supply voltage: 5V
- Low power consumption
- Low distortion
- Low clock Jitter sensitivity
- High SNR ratio range
- Wide temperature range
- 8-pin SOP package

### General Description

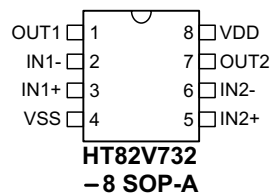
HT82V732 is a class AB stereo earphone driver designed for portable digital audio application. It provides 8-SOP package. Pin assignments and application circuit is compatible with TDA1308 which is suitable for ef-

fective low cost applications. HT82V732 is ideal for portable digital audio equipment, CD ROM/DVD ROM and DISCMAN system.

### Block Diagram



### Pin Assignment



### Pin Description

Pin No.	Pin Name	I/O	Description
1	OUT1	O	Output
2	IN1-	I	Inverting input
3	IN1+	I	Non-inverting input
4	VSS	—	Negative power supply, ground
5	IN2+	I	Non-inverting input
6	IN2-	I	Inverting input
7	OUT2	O	Output
8	VDD	—	Positive power supply

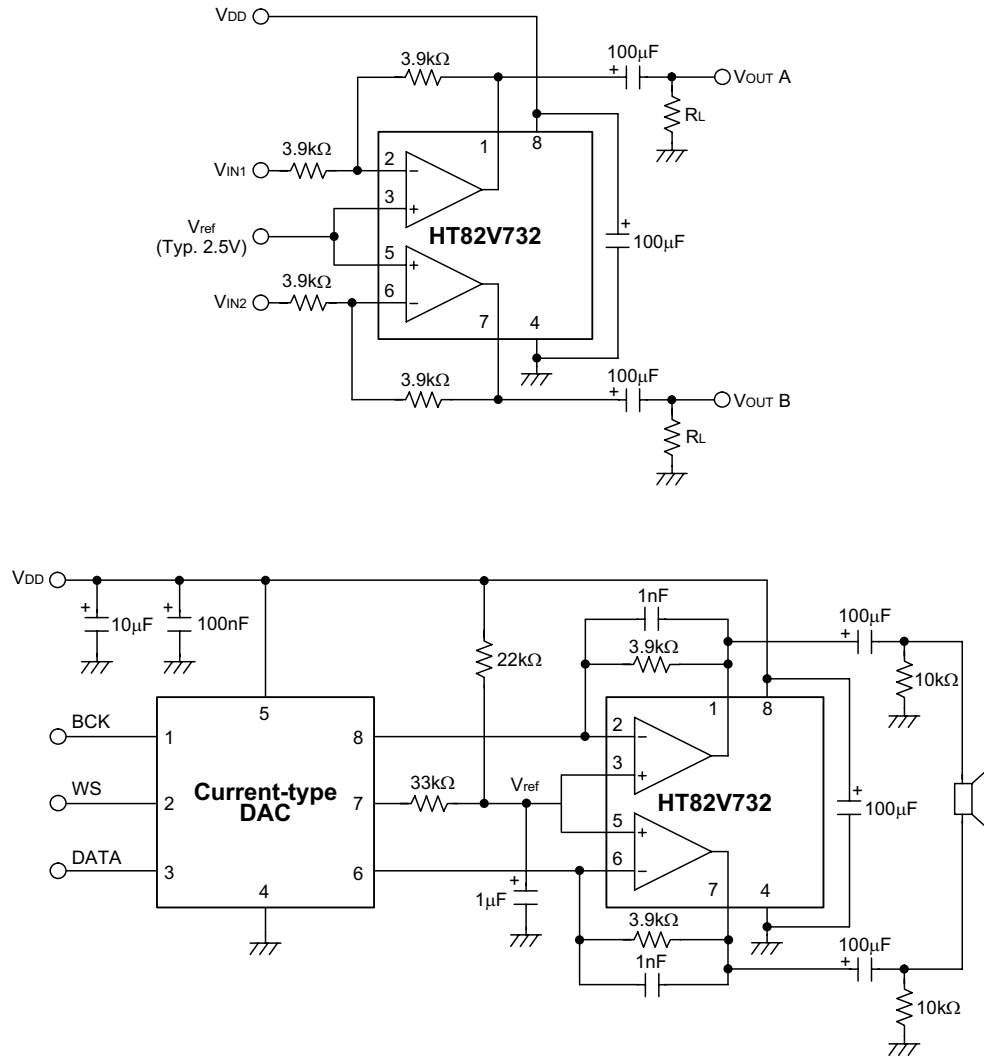
**Electrical Characteristics**
 $V_{SS}=0V$ ;  $f_i=1kHz$ ;  $R_L=32\Omega$ 

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V <sub>DD</sub>	Conditions				
Supplies							
V <sub>DD</sub>	Supply Voltage	5V	—	—	—	—	V
	Single			3.0	5.0	6.0	
	Dual			1.5	2.5	3	
V <sub>SS</sub>	Negative Supply Voltage	5V	—	−1.5	−2.5	−3	V
I <sub>DD</sub>	Supply Current	5V	No load	—	3	5	mA
P <sub>tot</sub>	Total Power Dissipation	5V	No load	—	15	25	mW
DC Characteristics							
V <sub>I(OS)</sub>	Input Offset Voltage	5V	—	—	10	—	mV
I <sub>bias</sub>	Input Bias Current	5V	—	—	10	—	pA
V <sub>CM</sub>	Common Mode Voltage	5V	—	0	—	3.5	V
G <sub>V</sub>	Open-loop Voltage Gain	5V	R <sub>L</sub> =5kΩ	—	70	—	dB
I <sub>O</sub>	Maximum Output Current	5V	(THD+N)/S<0.1%	—	60	—	mA
R <sub>O</sub>	Output Resistance	5V	—	—	0.25	—	Ω
V <sub>O</sub>	Output Voltage swing	5V	R <sub>L</sub> =32Ω *	0.75	—	4.25	V
			R <sub>L</sub> =16Ω *	1.5	—	3.5	
			R <sub>L</sub> =5kΩ *	0.1	—	4.9	
PSRR	Power Supply Rejection Ratio	5V	F <sub>I</sub> =100Hz; V <sub>ripple(p-p)</sub> =100mV	—	90	—	dB
α <sub>CS</sub>	Channel Separation	5V	—	—	70	—	dB
C <sub>L</sub>	Load Capacitance	5V	—	—	—	200	pF
AC Characteristics							
(THD+N)/S	Total Harmonic Distortion Plus Noise-to-signal Ratio	5V	V <sub>O(P-P)</sub> =3.5V **	—	−70	—	dB
				—	0.03	—	%
S/N	Signal-to-noise Ratio	5V	—	—	100	—	dB
f <sub>G</sub>	Unity Gain Frequency	5V	Open-loop; R <sub>L</sub> =5kΩ	—	5.5	—	MHz
P <sub>O</sub>	Maximum Output Power	5V	(THD+N)/S<0.1%	—	60	—	mW
C <sub>i</sub>	Input Capacitance	5V	—	—	3	—	pF
SR	Slew Rate	5V	Unity gain inverting	—	5	—	V/μs
B	Power Bandwidth	5V	Unity gain inverting	—	20	—	kHz

Note: \*\*\* Values are proportional to  $V_{DD}$ ;  $(THD+N)/S < 0.1\%$

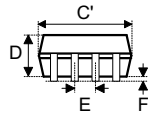
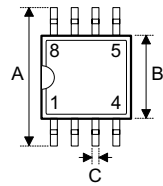
\*\*\*\*  $V_{DD}=5V$ ,  $V_{O(P-P)}=3.5V$  (at odB)

# Application Circuits



**Package Information**

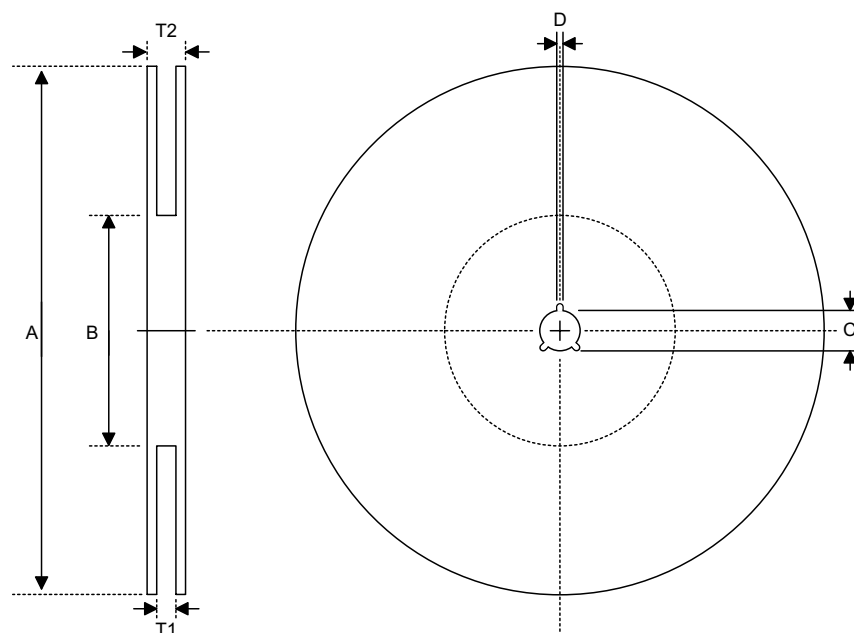
8-pin SOP (150mil) outline dimensions



Symbol	Dimensions in mil		
	Min.	Nom.	Max.
A	228	—	244
B	149	—	157
C	14	—	20
C'	189	—	197
D	53	—	69
E	—	50	—
F	4	—	10
G	22	—	28
H	4	—	12
$\alpha$	0°	—	10°

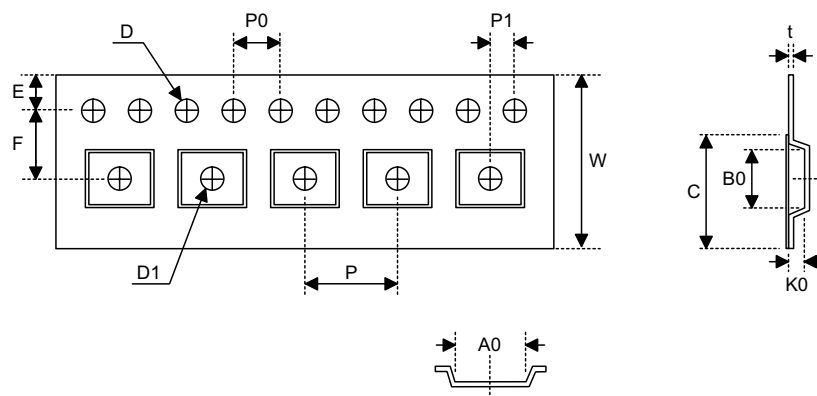
# Product Tape and Reel Specifications

## Reel dimensions



## SOP 8N

Symbol	Description	Dimensions in mm
A	Reel Outer Diameter	330±1.0
B	Reel Inner Diameter	62±1.5
C	Spindle Hole Diameter	13.0+0.5 -0.2
D	Key Slit Width	2.0±0.15
T1	Space Between Flange	12.8+0.3 -0.2
T2	Reel Thickness	18.2±0.2

**Carrier tape dimensions**

**SOP 8N**

Symbol	Description	Dimensions in mm
W	Carrier Tape Width	$12.0+0.3$ $-0.1$
P	Cavity Pitch	$8.0\pm0.1$
E	Perforation Position	$1.75\pm0.1$
F	Cavity to Perforation (Width Direction)	$5.5\pm0.1$
D	Perforation Diameter	$1.55\pm0.1$
D1	Cavity Hole Diameter	$1.5+0.25$
P0	Perforation Pitch	$4.0\pm0.1$
P1	Cavity to Perforation (Length Direction)	$2.0\pm0.1$
A0	Cavity Length	$6.4\pm0.1$
B0	Cavity Width	$5.20\pm0.1$
K0	Cavity Depth	$2.1\pm0.1$
t	Carrier Tape Thickness	$0.3\pm0.05$
C	Cover Tape Width	9.3

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